

N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D Max T _A = +25°C
60V	3Ω @ V _{GS} = 10V	334mA
607	4Ω @ V _{GS} = 4.5V	289mA

Description and Applications

This MOSFET is designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP and is ideal for use in:

- Motor Control
- Power Management Functions

Features and Benefits

- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Small Surface Mount Package
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The 2N7002EQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

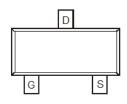
https://www.diodes.com/quality/product-definitions/

Mechanical Data

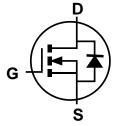
- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Alloy 42 Leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208 <a>3
- Weight: 0.008 grams (Approximate)



Top View



Top View Pin Out Configuration



Equivalent Circuit

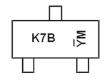
Ordering Information (Note 4)

Part Number	Case	Packaging
2N7002EQ-7-F	SOT23	3,000/Tape & Reel
2N7002EQ-13-F	SOT23	10,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



 $\begin{array}{l} \text{K7B} = \text{Product Type Marking Code} \\ \overline{Y}\text{M} = \text{Date Code Marking} \\ \overline{Y} = \text{Year (ex: H} = 2020) \\ \text{M} = \text{Month (ex: 9} = \text{September)} \end{array}$

Date Code Key

Year	2020	2021	2022	2023	2024	2025	2026	2027	2028	2029	2030	2031
Code	Н	- 1	J	K	L	М	N	0	Р	R	S	T
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage			VDSS	60	V
Gate-Source Voltage			V _{GSS}	±20	V
Continuous Drain Current (Note 5) V _{GS} = 10V	Steady State	T _A = +25°C T _A = +70°C	I _D	292 233	mA
Continuous Drain Current (Note 6) $V_{GS} = 10V$ Steady $T_A = +25^{\circ}C$ State $T_A = +70^{\circ}C$			lo	334 267	mA
Maximum Body Diode Forward Current (Note 6)			Is	334	mA
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1	%)		I _{DM}	1	А

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Power Dissipation (Note 5)		PD	0.5	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	Reja	244	°C/W
Power Dissipation (Note 6)		P _D	0.7	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	Reja	186	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

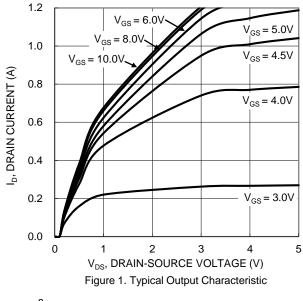
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BVDSS	60	_	_	V	V _G S = 0V, I _D = 10μA
Zero Gate Voltage Drain Current	I _{DSS}	_	_	1.0	μΑ	V _{DS} = 60V, V _{GS} = 0V
Gate-Body Leakage	Igss	_	_	±100	nA	V _G S = ±20V, V _D S = 0V
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V _{GS(TH)}	1.0	_	2.5	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$
Static Drain-Source On-Resistance	RDS(ON)		1.3 1.6	3 4	Ω	$V_{GS} = 10V, I_D = 250mA$ $V_{GS} = 4.5V, I_D = 200mA$
Diode Forward Voltage	VsD		0.8	1.5	V	V _G S = 0V, I _S = 115mA
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	Ciss		35	_	pF	
Output Capacitance	Coss	_	4.4	_	pF	V _{DS} = 30V, V _{GS} = 0V, f = 1.0MHz
Reverse Transfer Capacitance	C _{rss}	_	2.8	_	pF	
Gate Resistance	Rg	_	188	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	0.3	_	nC	
Total Gate Charge (V _{GS} = 10V)	Qg	_	0.5	_	nC	001/1 050 4
Gate-Source Charge	Q _{gs}	_	0.1	_	nC	VDS = 30V, ID = 250mA
Gate-Drain Charge	Qgd	_	0.1	_	nC	
Turn-On Delay Time	t _{D(ON)}	_	5	_		
Turn-On Rise Time	t _R	_	2	_	ns	V _{DD} = 30V, V _{GS} = 10V,
Turn-Off Delay Time	tD(OFF)		26	—	115	$Rg = 25\Omega, I_D = 200mA$
Turn-Off Fall Time	tF		13	_		
Reverse Recovery Time	t _{RR}	_	18	_	ns	L_ 10 di/dt 1000/up
Reverse Recovery Charge	Qrr	_	8.6	_	nC	I _F = 1A, di/dt = 100A/μs

Notes:

- 5. Device mounted on FR-4 PCB, with minimum recommended pad layout.
- 6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.
- 7. Short duration pulse test used to minimize self-heating effect.
- 8. Guaranteed by design. Not subject to product testing.





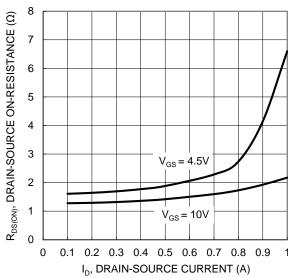


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

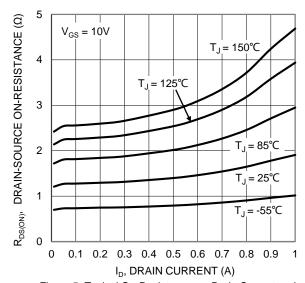
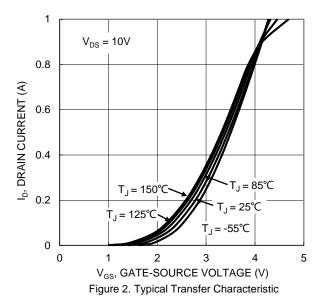


Figure 5. Typical On-Resistance vs. Drain Current and Temperature



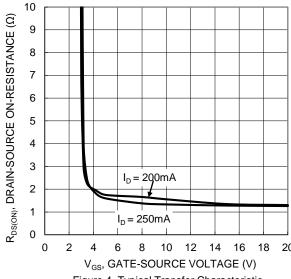


Figure 4. Typical Transfer Characteristic

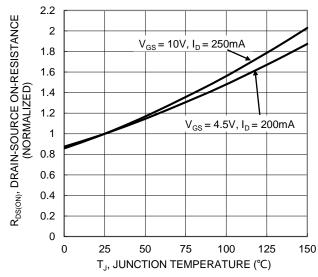


Figure 6. On-Resistance Variation with Temperature



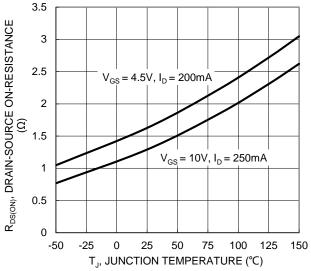
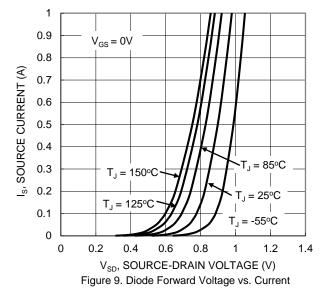
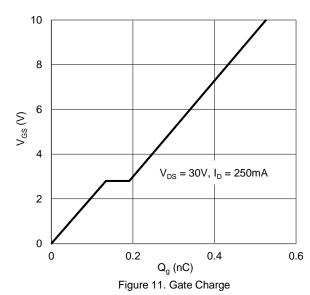


Figure 7. On-Resistance Variation with Temperature





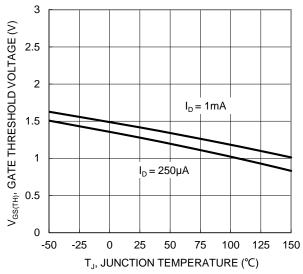
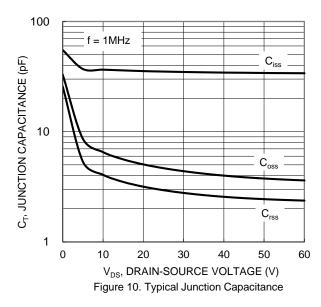


Figure 8. Gate Threshold Variation vs. Junction Temperature



10 $R_{\text{DS}(\text{ON})}$ $P_W = 100 \mu s$ 1 DRAIN CURRENT (A) 0.1 T_{J(Max)} = 150°C T_A = 25℃ 0.01 Single Pulse DUT on 1*MRP board $V_{GS} = 10V$ 0.001 0.1 10 100 V_{DS}, DRAIN-SOURCE VOLTAGE (V) Figure 12. SOA, Safe Operation Area



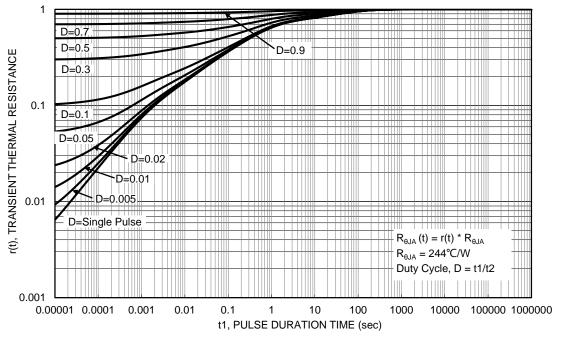


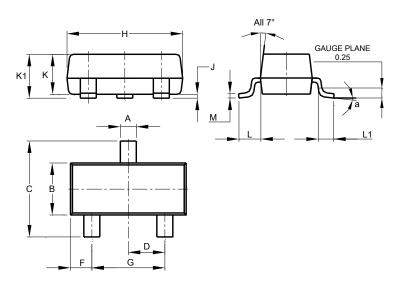
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT23

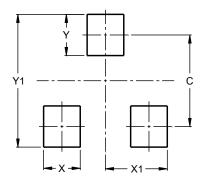


SOT23						
Dim	Min	Max	Тур			
Α	0.37	0.51	0.40			
В	1.20	1.40	1.30			
С	2.30	2.50	2.40			
D	0.89	1.03	0.915			
F	0.45	0.60	0.535			
G	1.78	2.05	1.83			
Н	2.80	3.00	2.90			
7	0.013	0.10	0.05			
K	0.890	1.00	0.975			
K 1	0.903	1.10	1.025			
٦	0.45	0.61	0.55			
L1	0.25	0.55	0.40			
М	0.085	0.150	0.110			
а	0°	8°				
All	All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT23



Dimensions	Value (in mm)
С	2.0
Х	0.8
X1	1.35
Y	0.9
V1	2.0

November 2020

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